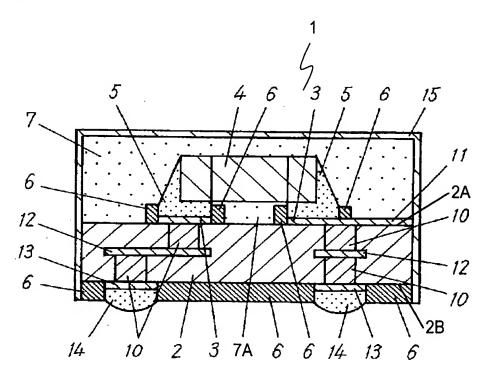
Fig. 1A



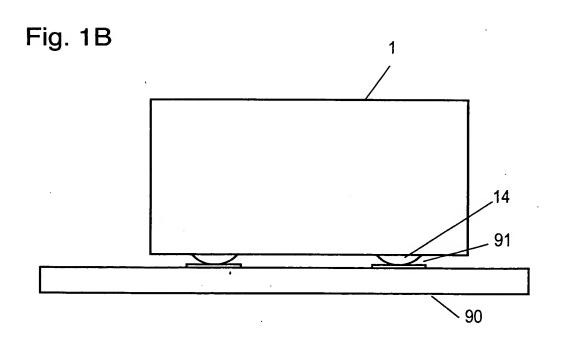


Fig. 2

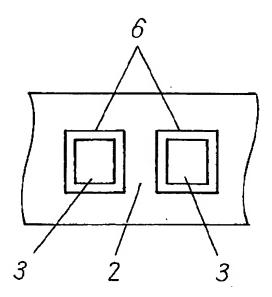


Fig. 3

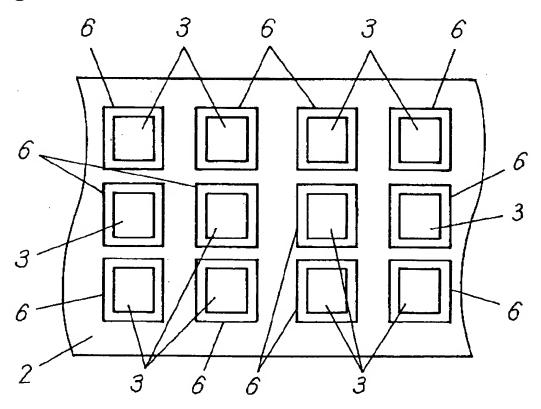


Fig. 4

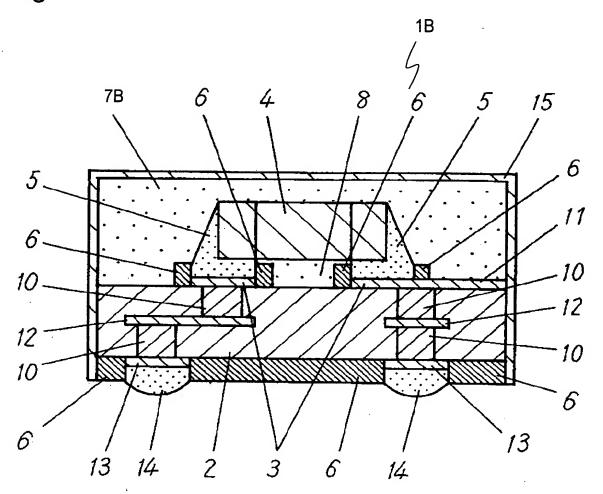


Fig. 5

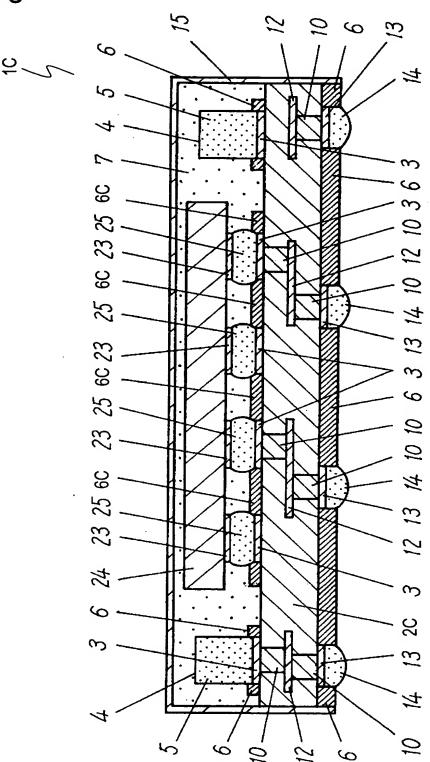
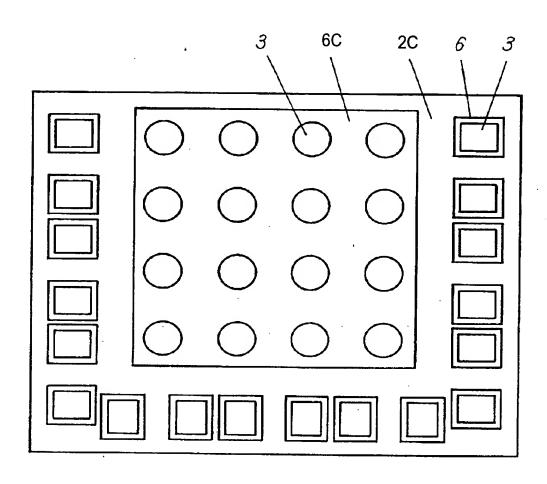


Fig. 6





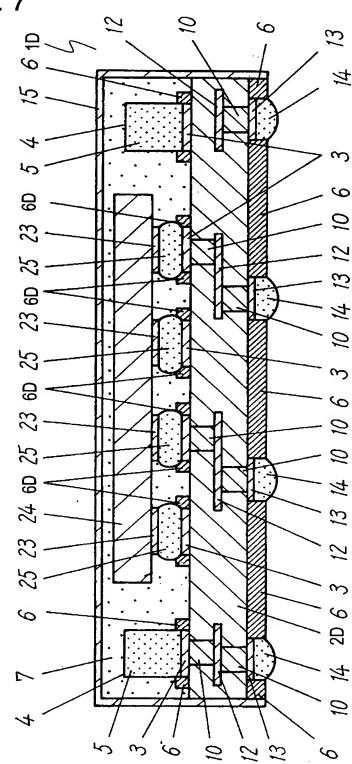


Fig. 8

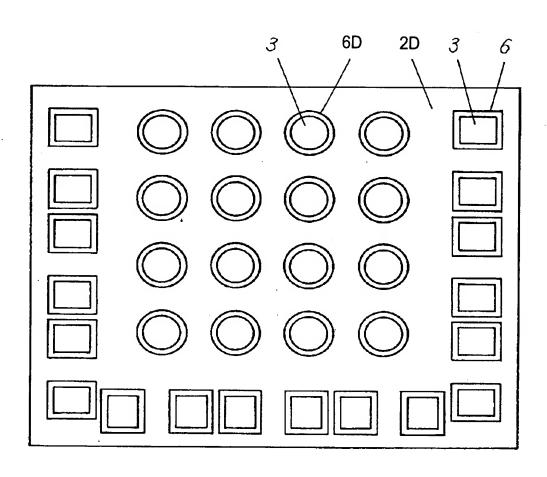


Fig. 9

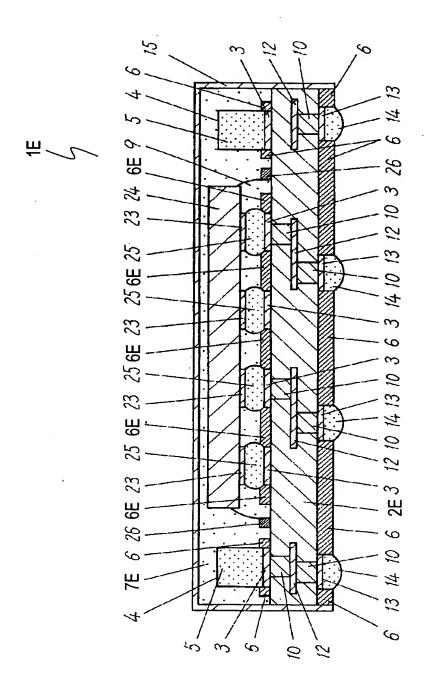


Fig. 10

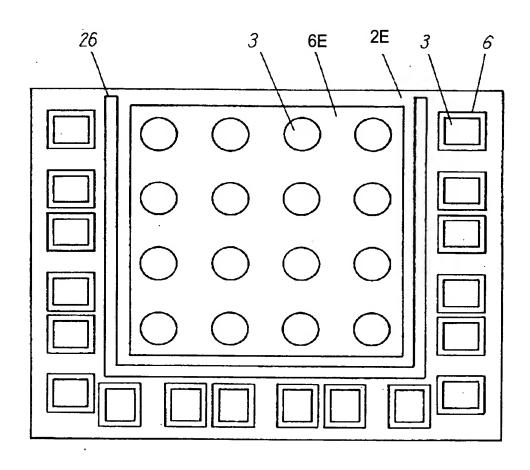


Fig. 11

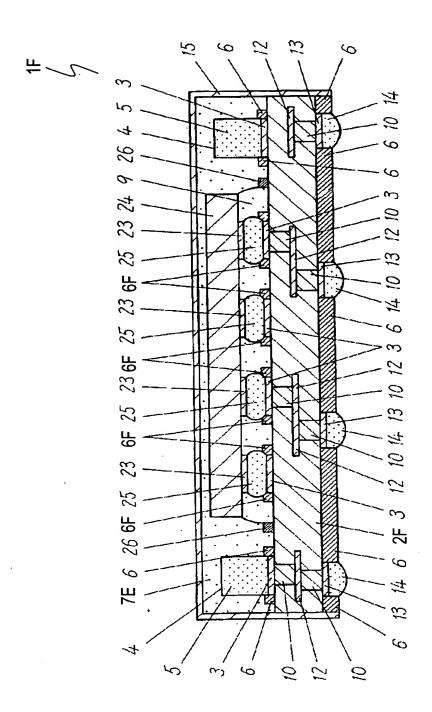
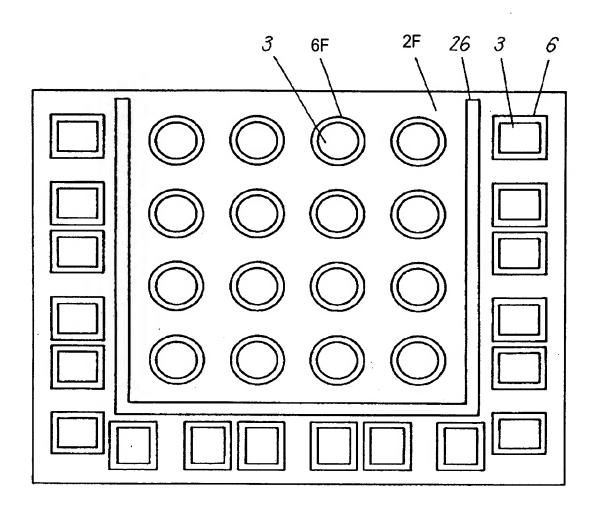
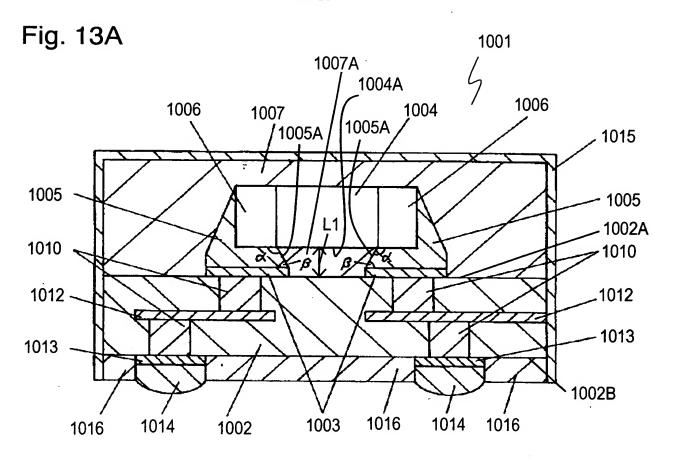


Fig. 12





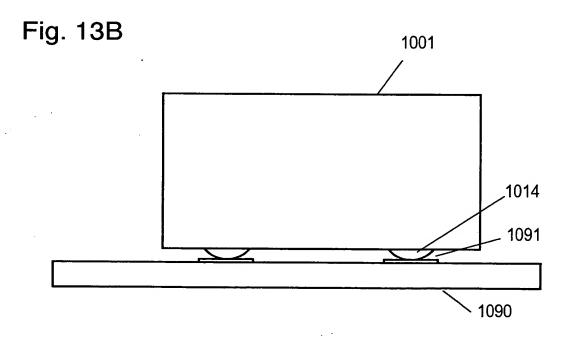


Fig. 14A

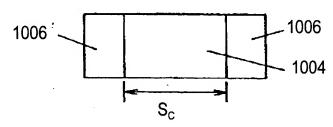
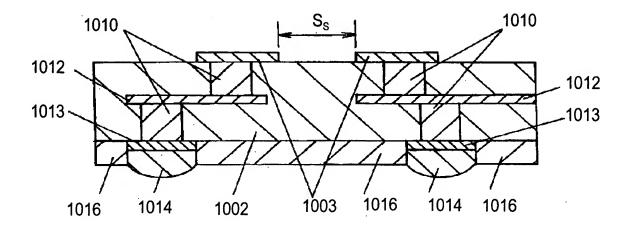


Fig. 14B





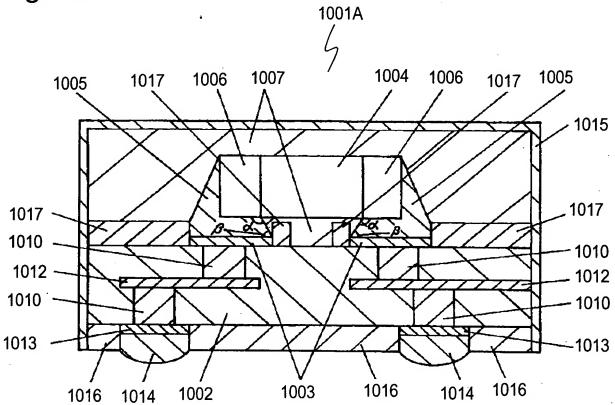


Fig. 16

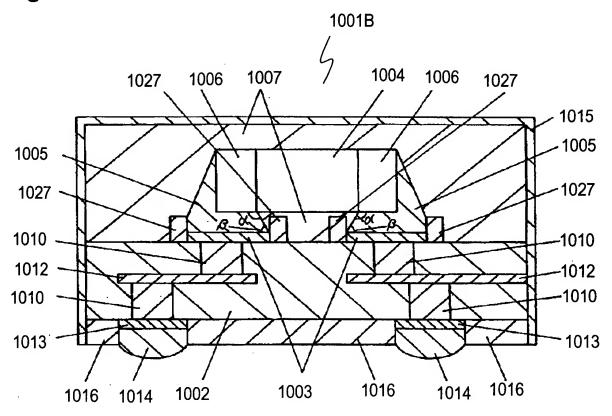
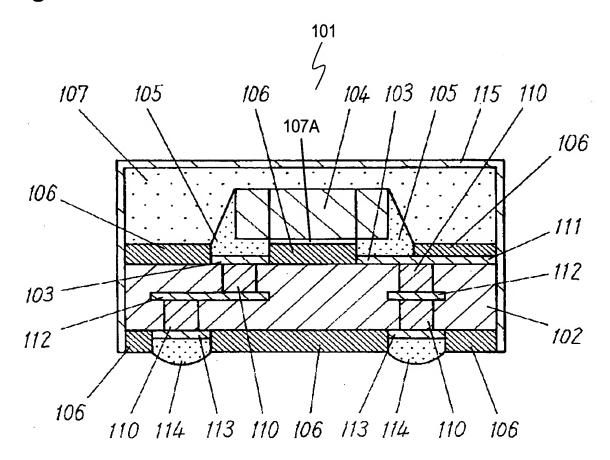
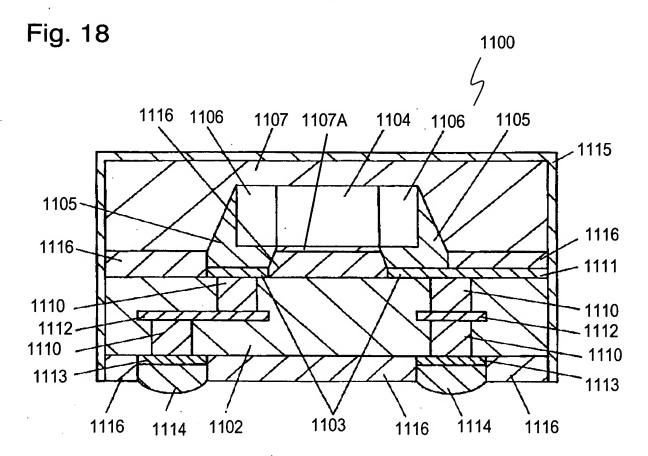


Fig. 17





Refere	ence Numerals
1	Module
1B	Module
1C	Module
1D	Module
1E	Module
1F	Module
2	Wiring Board
2C	Wiring Board
2D	Wiring Board
2E	Wiring Board
$2\mathbf{F}$	Wiring Board
3	Electrode
4	Electronic Component
5	Solder
6	Solder Resist
6C	Solder Resist
6D	Solder Resist
6E	Solder Resist
6F	Solder Resist
7	Insulating Resin
7B	Insulating Resin
7E	Insulating Resin
9	Insulating Resin
10	Inner Via
11	Wiring Pattern
12	Wiring Pattern
13	Backside Electrode
14	Solder
15	Metallic Film
23	Electrode
24	Electronic Component
25	Solder

Wall of Solder Resist

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90	Motherboard
91	Electrode
1001	Module
1002	Wiring Board
1003	Electrode
1004	Electronic Component
1005	Solder
1006	Solder Resist
1007	Insulating Resin
1007A	Insulating Resin
1010	Inner Via
1011	Wiring Pattern
1012	Wiring Pattern
1013	Backside Electrode
1014	Solder
1015	Metallic Film
1016	Solder Resist
1017	Solder Resist
1023	Electrode
1024	Electronic Component
1025	Solder
1027	Solder Resist
1090	Motherboard
1091	Electrode